



# **SPECIFICATION**

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL21B333KBANNWC

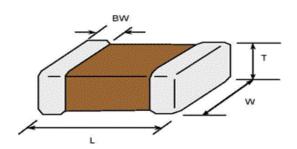
· Product : Multi-layer Ceramic Capacitor · Description : CAP, 33nF, 50V, ±10%, X7R, 0805

# A. Samsung Part Number

<u>CL</u> <u>21</u> <u>B</u> <u>333</u> <u>K</u> <u>B</u> <u>A</u> <u>N</u> <u>N</u> <u>W</u> <u>C</u> 1 2 3 4 5 6 7 8 9 10 11

| 1   | Series        | Samsung Multi-layer Ceramic Capacitor |         |                 |    |                  |            |
|-----|---------------|---------------------------------------|---------|-----------------|----|------------------|------------|
| 2   | Size          | 0805 (inch code)                      | L: 2.00 | ± 0.10 mm       | W: | $1.25\pm0.10$ mm |            |
| 3   | Dielectric    | X7R                                   | 8       | Inner electrode |    | Ni               |            |
| 4   | Capacitance   | 33 nF                                 |         | Termination     |    | Cu               |            |
| (5) | Capacitance   | ±10 %                                 |         | Plating         |    | Sn 100%          | (Pb Free)  |
|     | tolerance     |                                       | 9       | Product         |    | Normal           |            |
| 6   | Rated Voltage | 50 V                                  | 10      | Special         |    | Industrial (Netw | ork,etc)   |
| 7   | Thickness     | $0.65 \pm 0.10 \text{ mm}$            | 11      | Packaging       |    | Cardboard Type   | e, 7" reel |

### **B. Structure & Dimension**



| Samsung P/N     | Dimension(mm) |             |             |                |  |  |
|-----------------|---------------|-------------|-------------|----------------|--|--|
| Samsung F/N     | L             | W           | Т           | BW             |  |  |
| CL21B333KBANNWC | 2.00 ± 0.10   | 1.25 ± 0.10 | 0.65 ± 0.10 | 0.50 +0.2/-0.3 |  |  |

#### C. Samsung Reliablility Test and Judgement Condition

|                   | Judgement  | Test condition   |  |  |
|-------------------|--|--|--|--|
| Capacitance       | Within specified tolerance   | 1kHz ±10% / 1.0±0.2Vrms  |  |  |
| Tan δ (DF)        | 0.025 max.   | *A capacitor prior to measuring the capacitance is heat treated at 150 ℃ +0/-10 ℃ for 1 hour and maintained in ambient air for 24±2 hours. |  |  |
| Insulation        | 10,000Mohm or 500Mohm×μF   | Rated Voltage 60~120 sec.  |  |  |
| Resistance        | Whichever is smaller   |  |  |  |
| Appearance        | No abnormal exterior appearance  | Microscope (×10)   |  |  |
| Withstanding      | No dielectric breakdown or   | 250% of the rated voltage  |  |  |
| Voltage           | mechanical breakdown   |  |  |  |
| Temperature       | X7R  |  |  |  |
| Characteristics   | (From-55℃ to 125℃, Capacitance change                                  | should be within ±15%)   |  |  |
| Adhesive Strength | No peeling shall be occur on the                                       | 500g·f, for 10±1 sec.  |  |  |
| of Termination    | terminal electrode   |  |  |  |
| Bending Strength  | Capacitance change: within ±12.5%                                      | Bending to the limit (1mm)   |  |  |
|                   |  | with 1.0mm/sec.  |  |  |
| Solderability     | More than 75% of terminal surface                                      | SnAg3.0Cu0.5 solder  |  |  |
|                   | is to be soldered newly  | 245±5°C, 3±0.3sec.   |  |  |
|                   |  | (preheating : 80~120°C for 10~30sec.)  |  |  |
| Resistance to     | Capacitance change : within ±7.5%                                      | Solder pot : 270±5°C, 10±1sec.   |  |  |
| Soldering Heat    | Tan δ, IR : initial spec.  |  |  |  |
| Vibration Test    | Capacitance change : within $\pm$ 5% Tan $\delta$ , IR : initial spec. | Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)  |  |  |
| Moisture          | Capacitance change: within ±12.5%                                      | With rated voltage   |  |  |
| Resistance        | Tan δ: 0.05 max  | 40±2°C, 90~95%RH, 500+12/-0hrs   |  |  |
|                   | IR: 500Mohm or 25Mohm × <i>μ</i> F                                     |  |  |  |
|                   | Whichever is smaller   |  |  |  |
| High Temperature  | Capacitance change: within ±12.5%                                      | With 200% of the rated voltage   |  |  |
| Resistance        | Tan δ : 0.05 max   | Max. operating temperature   |  |  |
|                   | IR : 1,000Mohm or 50Mohm × <i>μ</i> F                                  | 1,000+48/-0hrs   |  |  |
|                   | Whichever is smaller   |  |  |  |
| Temperature       | Capacitance change: within ±7.5%                                       | 1 cycle condition  |  |  |
| Cycling           | Tan δ, IR : initial spec.  | Min. operating temperature → 25°C  |  |  |
|                   |  | → Max. operating temperature → 25°C  |  |  |
|                   |  | 5 cycle test   |  |  |
|                   |  |  |  |  |

X The reliability test condition can be replaced by the corresponding accelerated test condition.

## D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260±5°C, 30sec. )



A Product specifications included in the specifications are effective as of March 1, 2013.

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- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.